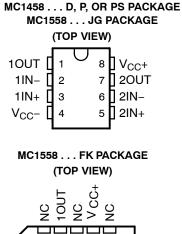
SLOS069C - FEBRUARY 1971 - REVISED AUGUST 2010

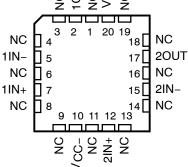
- Short-Circuit Protection
- Wide Common-Mode and Differential Voltage Ranges
- No Frequency Compensation Required
- Low Power Consumption
- No Latch-Up
- Designed to Be Interchangeable With Motorola MC1558/MC1458 and Signetics S5558/N5558

#### description/ordering information

The MC1458 and MC1558 are dual general-purpose operational amplifiers, with each half electrically similar to the  $\mu$ A741, except that offset null capability is not provided.

The high-common-mode input voltage range and the absence of latch-up make these amplifiers ideal for voltage-follower applications. The devices are short-circuit protected and the internal frequency compensation ensures stability without external components.





NC - No internal connection

#### **ORDERING INFORMATION**

| T <sub>A</sub> | V <sub>IO</sub> max<br>AT 25°C | PACKAGE <sup>†</sup> |               | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>MARKING |
|----------------|--------------------------------|----------------------|---------------|--------------------------|---------------------|
|                |                                | PDIP (P)             | Tube          | MC1458P                  | MC1458P             |
| 000 1. 7000    | 0)/                            |                      | Tube          | MC1458D                  | M04450              |
| 0°C to 70°C    | 6 mV                           | SOIC (D)             | Tape and reel | MC1458DR                 | MC1458              |
|                |                                | SOP (PS)             | Tape and reel | MC1458PSR                | M1458               |
|                |                                | CDIP (JG)            | Tube          | MC1558JG                 | MC1558JG            |
| –55°C to 125°C | 5 mV                           | CDIP (JGB)           | Tube          | MC1558JGB                | MC1558JGB           |
|                |                                | LCCC (FK)            | Tube          | MC1558FK                 | MC1558FK            |

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

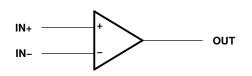
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



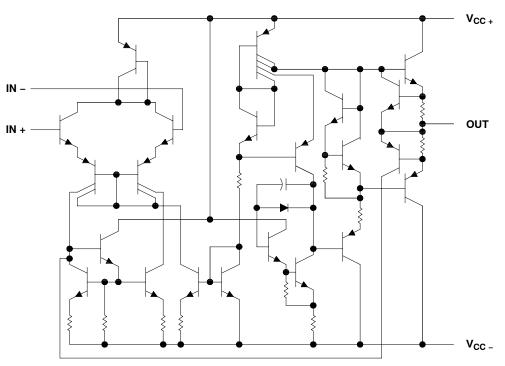
 $Copyright © 2002, \ Texas \ Instruments \ Incorporated \\ On products \ compliant to \ MIL-PRF-3853, all parameters are tested \\ unless \ otherwise \ noted. \ On all \ other \ products, \ products,$ 

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#### symbol (each amplifier)



### schematic (each amplifier)





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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

| Supply voltage, V <sub>CC+</sub> (see Note 1): | MC1459               |                              | 10 \/          |
|--|----------------------|------------------------------|----------------|
| Supply vollage, vCC+ (see Note 1).             |                      |                              |                |
|  | MC1558               |                              |                |
| Supply voltage, V <sub>CC</sub> (see Note 1):  | MC1458               |                              | 18 V           |
|  | MC1558               |                              | 22 V           |
| Differential input voltage, VID (see No        | ote 2)               |                              | ±30 V          |
| Input voltage, VI (either input, see No        |                      |                              |                |
| Duration of output short circuit (see I        |                      |                              |                |
| Operating virtual junction temperatur          | -                    |                              |                |
| Package thermal impedance, $\theta_{JA}$ (see  | -                    |                              |                |
|  | ,                    | P package                    | 85°C/W         |
|  |                      | PS package                   |                |
| Package thermal impedance, $\theta_{JC}$ (see  | ee Notes 7 and 8):   |                              |                |
|  | ,                    | JG package                   | 14.5°C/W       |
| Case temperature for 60 seconds: F             |                      |                              |                |
| Lead temperature 1,6 mm (1/16 inch             | ) from case for 10   | seconds: JG package          | 300°C          |
| Lead temperature 1,6 mm (1/16 inch             | ) from case for 60 : | seconds: D, P, or PS package | 260°C          |
| Storage temperature range, T <sub>stg</sub>    | ·                    |                              | –65°C to 150°C |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, unless otherwise noted, are with respect to the midpoint between  $V_{CC+}$  and  $V_{CC-}$ .
  - 2. Differential voltages are at IN+ with respect to IN -.
  - 3. The magnitude of the input voltage must never exceed the magnitude of the supply voltage or 15 V, whichever is less.
  - 4. The output can be shorted to ground or either power supply. For the MC1558 only, the unlimited duration of the short circuit applies at (or below) 125°C case temperature or 70°C free-air temperature.
  - 5. Maximum power dissipation is a function of  $T_J(max)$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(max) T_A)/\theta_{JA}$ . Operating at the absolute maximum  $T_J$  of 150°C can affect reliability.
  - 6. The package thermal impedance is calculated in accordance with JESD 51-7.
  - 7. Maximum power dissipation is a function of  $T_J(max)$ ,  $\theta_{JC}$ , and  $T_C$ . The maximum allowable power dissipation at any allowable case temperature is  $P_D = (T_J(max) T_C)/\theta_{JC}$ . Operating at the absolute maximum  $T_J$  of 150°C can affect reliability.
  - 8. The package thermal impedance is calculated in accordance with MIL-STD-883.

#### recommended operating conditions

|             |                                      |        | MIN | MAX | UNIT |
|-------------|--------------------------------------|--------|-----|-----|------|
| $V_{CC\pm}$ | Supply voltage                       |        | ±5  | ±15 | V    |
| -           |                                      | MC1458 | 0   | 70  | °C   |
| ١A          | Operating free-air temperature range | -55    | 125 | -0  |      |



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### electrical characteristics at specified free-air temperature, V\_{CC\pm} = $\pm 15$ V

|                                  |  |   |                                       | Ν          | IC1458 |     | Ν   |      |     |      |       |
|----------------------------------|--|---|---------------------------------------|------------|--------|-----|-----|------|-----|------|-------|
|                                  | PARAMETER  | TES   |                                       | MIN        | ТҮР    | MAX | MIN | TYP  | MAX | UNIT |       |
|                                  |  |   |                                       | 25°C       |        | 1   | 6   |      | 1   | 5    |       |
| V <sub>IO</sub>                  | Input offset voltage                                 | V <sub>O</sub> = 0  |                                       | Full range |        |     | 7.5 |      |     | 6    | mV    |
|                                  |  |   |                                       | 25°C       |        | 20  | 200 |      | 20  | 200  |       |
| I <sub>IO</sub>                  | Input offset current                                 | V <sub>O</sub> = 0  |                                       | Full range |        |     | 300 |      |     | 500  | nA    |
|                                  |  |   |                                       | 25°C       |        | 80  | 500 |      | 80  | 500  |       |
| I <sub>IB</sub>                  | Input bias current                                   | V <sub>O</sub> = 0  |                                       | Full range |        |     | 800 |      |     | 1500 | nA    |
|                                  | Common-mode input                                    |   |                                       | 25°C       | ±12    | ±13 |     | ±12  | ±13 |      |       |
| V <sub>ICR</sub>                 | voltage range  |   | Ĩ                                     |            | ±12    |     |     | ±12  |     |      | V     |
|                                  |  | $R_L = 10 \ k\Omega$  |                                       | 25°C       | ±12    | ±14 |     | ±12  | ±14 |      |       |
| .,                               | Maximum peak output                                  | $R_L \ge 10 \ k\Omega$  |                                       | Full range | ±12    |     |     | ±11  |     |      | .,    |
| V <sub>OM</sub>                  | VOM voltage swing                                    | $R_L = 2 k\Omega$   |                                       | 25°C       | ±10    | ±13 |     | ±10  | ±13 |      | V     |
|                                  |  | $R_L \ge 2 k\Omega$   |                                       | Full range | ±10    |     |     | ±10  |     |      |       |
| Large-signal differential        |  |   | 25°C                                  | 20         | 200    |     | 50  | 200  |     |      |       |
| A <sub>VD</sub>                  | voltage amplification                                | $R_L \ge 2 k\Omega$ ,   | V <sub>O</sub> = ±10 V                | Full range | 15     |     |     | 25   |     |      | V/mV  |
| B <sub>OM</sub>                  | Maximum-output-swing<br>bandwidth<br>(closed loop)   | $\begin{array}{l} R_{L} = 2 \; k \Omega, \\ A_{VD} \; = 1, \end{array}$ | $V_O \ge \pm 10 V$ ,<br>THD $\ge 5\%$ | 25°C       |        | 14  |     |      | 14  |      | kHz   |
| B <sub>1</sub>                   | Unity-gain bandwidth                                 |   |                                       | 25°C       |        | 1   |     |      | 1   |      | MHz   |
| φm                               | Phase margin   | A <sub>VD</sub> = 1   |                                       | 25°C       |        | 65  |     |      | 65  |      | deg   |
|                                  | Gain margin  |   |                                       | 25°C       |        | 11  |     |      | 11  |      | dB    |
| r <sub>i</sub>                   | Input resistance                                     |   |                                       | 25°C       | 0.3    | 2   |     | 0.3* | 2   |      | MΩ    |
| r <sub>o</sub>                   | Output resistance                                    | V <sub>O</sub> = 0,   | See Note 9                            | 25°C       |        | 75  |     |      | 75  |      | Ω     |
| Ci                               | Input capacitance                                    |   |                                       | 25°C       |        | 1.4 |     |      | 1.4 |      | pF    |
| z <sub>ic</sub>                  | Common-mode input impedance                          | f = 20 Hz   |                                       | 25°C       |        | 200 |     |      | 200 |      | MΩ    |
| 01455                            | Common-mode  | V <sub>IC</sub> = V <sub>ICR</sub> m                                    | iin,                                  | 25°C       | 70     | 90  |     | 70   | 90  |      | 9     |
| CMRR                             | rejection ratio                                      | $V_0 = 0$   |                                       | Full range | 70     |     |     | 70   |     |      | dB    |
|                                  | Supply-voltage                                       | V <sub>CC</sub> = ±9 V t  | o +15 V                               | 25°C       |        | 30  | 150 |      | 30  | 150  |       |
| k <sub>SVS</sub>                 | sensitivity<br>(ΔV <sub>IO</sub> /ΔV <sub>CC</sub> ) | $V_{O} = 0$   | 0 ± 10 <b>v</b> ,                     | Full range |        |     | 150 |      |     | 150  | μV/V  |
| Vn                               | Equivalent input noise<br>voltage (closed loop)      | A <sub>VD</sub> = 100,<br>f = 1 kHz,                                    | R <sub>S</sub> = 0,<br>BW = 1 Hz      | 25°C       |        | 45  |     |      | 45  |      | nV/√H |
| I <sub>OS</sub>                  | Short-circuit output<br>current                      |   |                                       | 25°C       |        | ±25 | ±40 |      | ±25 | ±40  | mA    |
|                                  | Supply current                                       |   | 1                                     | 25°C       |        | 3.4 | 5.6 |      | 3.4 | 5    |       |
| Icc                              | (both amplifiers)                                    | V <sub>O</sub> = 0, No  | load                                  | Full range |        |     | 6.6 |      |     | 6.6  | mA    |
| <b>D</b>                         | Total power dissipation                              |   | l                                     | 25°C       |        | 100 | 170 |      | 100 | 150  |       |
| P <sub>D</sub>                   | (both amplifiers)                                    | V <sub>O</sub> = 0, No  | load                                  | Full range |        |     | 200 |      |     | 200  | mW    |
| V <sub>01</sub> /V <sub>02</sub> | Crosstalk attenuation                                |   |                                       | 25°C       |        | 120 |     |      | 120 |      | dB    |

\*On products compliant to MIL-PRF-38535, this parameter is not production tested.

<sup>†</sup> All characteristics are specified under open-loop operating conditions with zero common-mode input voltage, unless otherwise specified. Full range for MC1458 is 0°C to 70°C and for MC1558 is – 55°C to 125°C.

NOTE 9: This typical value applies only at frequencies above a few hundred hertz because of the effect of drift and thermal feedback.



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|                | $ \sum_{i=1}^{n} \sum_{j=1}^{n} \sum_{i=1}^{n} \sum_{i=1}^{n} \sum_{i=1}^{n} \sum_{j=1}^{n} \sum_{$ |                         |                     |     |        |                     |   |     |  |      |  |  |  |  |
|----------------|---|-------------------------|---------------------|-----|--------|---------------------|---|-----|--|------|--|--|--|--|
|                |   | TEAT OO                 |                     | Γ   | MC1458 |                     | Γ |     |  |      |  |  |  |  |
|                | PARAMETER   | TEST COI                | NDITIONS            | MIN | TYP    | TYP MAX MIN TYP MAX |   | MAX |  |      |  |  |  |  |
|                | Rise time   | V <sub>I</sub> = 20 mV, | $R_L = 2 k\Omega$ , |     | 0.3    |                     |   | 0.3 |  | μs   |  |  |  |  |
| t <sub>r</sub> | Overshoot factor  | V <sub>I</sub> = 20 mV, | $R_L = 2 k\Omega$   |     | 5      |                     |   | 5   |  | %    |  |  |  |  |
| SR             | Slew rate at unity gain   | V <sub>I</sub> = 10 V,  | $R_L = 2 k\Omega$   |     | 0.5    |                     |   | 0.5 |  | V/µs |  |  |  |  |

### operating characteristics, $V_{CC\pm} = \pm 15$ V, $C_L = 100$ pF, $T_A = 25^{\circ}C$ (see Figure 1)

### PARAMETER MEASUREMENT INFORMATION

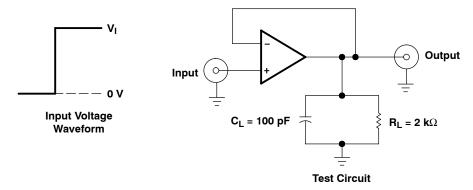


Figure 1. Rise-Time, Overshoot, and Slew-Rate Waveform and Test Circuit





28-Jul-2020

## **PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5)          | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|--------------------------------------|----------------------|--------------|----------------------------------|---------|
| 5962-9760301Q2A  | ACTIVE        | LCCC         | FK                 | 20   | 1              | TBD                        | POST-PLATE                           | N / A for Pkg Type   | -55 to 125   | 5962-<br>9760301Q2A<br>MC1558FKB | Samples |
| 5962-9760301QPA  | ACTIVE        | CDIP         | JG                 | 8    | 1              | TBD                        | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 9760301QPA<br>MC1558             | Samples |
| MC1458D          | ACTIVE        | SOIC         | D                  | 8    | 75             | Green (RoHS<br>& no Sb/Br) | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | MC1458                           | Samples |
| MC1458DE4        | ACTIVE        | SOIC         | D                  | 8    | 75             | Green (RoHS<br>& no Sb/Br) | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | MC1458                           | Samples |
| MC1458DR         | ACTIVE        | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | MC1458                           | Samples |
| MC1458DRE4       | ACTIVE        | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | MC1458                           | Samples |
| MC1458DRG4       | ACTIVE        | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | MC1458                           | Samples |
| MC1458P          | ACTIVE        | PDIP         | Ρ                  | 8    | 50             | Green (RoHS<br>& no Sb/Br) | NIPDAU                               | N / A for Pkg Type   | 0 to 70      | MC1458P                          | Samples |
| MC1458PE4        | ACTIVE        | PDIP         | Ρ                  | 8    | 50             | Green (RoHS<br>& no Sb/Br) | NIPDAU                               | N / A for Pkg Type   | 0 to 70      | MC1458P                          | Samples |
| MC1458PSR        | ACTIVE        | SO           | PS                 | 8    | 2000           | Green (RoHS<br>& no Sb/Br) | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | M1458                            | Samples |
| MC1558FKB        | ACTIVE        | LCCC         | FK                 | 20   | 1              | TBD                        | POST-PLATE                           | N / A for Pkg Type   | -55 to 125   | 5962-<br>9760301Q2A<br>MC1558FKB | Samples |
| MC1558JG         | ACTIVE        | CDIP         | JG                 | 8    | 1              | TBD                        | SNPB                                 | N / A for Pkg Type   | -55 to 125   | MC1558JG                         | Samples |
| MC1558JGB        | ACTIVE        | CDIP         | JG                 | 8    | 1              | TBD                        | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 9760301QPA<br>MC1558             | Samples |

<sup>(1)</sup> The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.



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<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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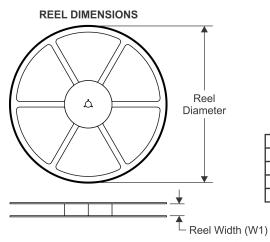
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## PACKAGE MATERIALS INFORMATION

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### TAPE AND REEL INFORMATION





### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



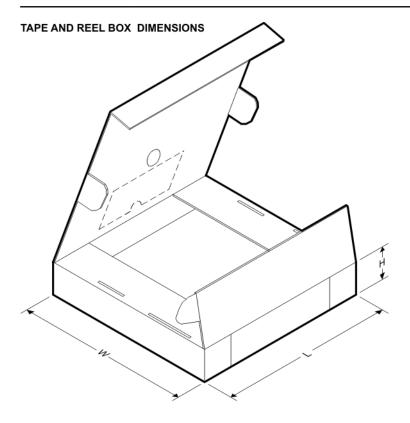
| *All di | mensions are nominal |                 |                    |   |      |                          |                          |            |            |            |            |           |                  |
|---------|----------------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
|         | Device               | Package<br>Type | Package<br>Drawing |   | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|         | MC1458DR             | SOIC            | D                  | 8 | 2500 | 330.0                    | 12.4                     | 6.4        | 5.2        | 2.1        | 8.0        | 12.0      | Q1               |
|         | MC1458DR             | SOIC            | D                  | 8 | 2500 | 330.0                    | 12.4                     | 6.4        | 5.2        | 2.1        | 8.0        | 12.0      | Q1               |

TEXAS INSTRUMENTS

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## PACKAGE MATERIALS INFORMATION

16-Oct-2020



\*All dimensions are nominal

| Device   | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------|--------------|-----------------|------|------|-------------|------------|-------------|
| MC1458DR | SOIC         | D               | 8    | 2500 | 853.0       | 449.0      | 35.0        |
| MC1458DR | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |

LEADLESS CERAMIC CHIP CARRIER

FK (S-CQCC-N\*\*) 28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



# D0008A



## **PACKAGE OUTLINE**

## SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



#### NOTES:

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.

- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.
- 5. Reference JEDEC registration MS-012, variation AA.



# D0008A

# **EXAMPLE BOARD LAYOUT**

## SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



## D0008A

# **EXAMPLE STENCIL DESIGN**

## SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

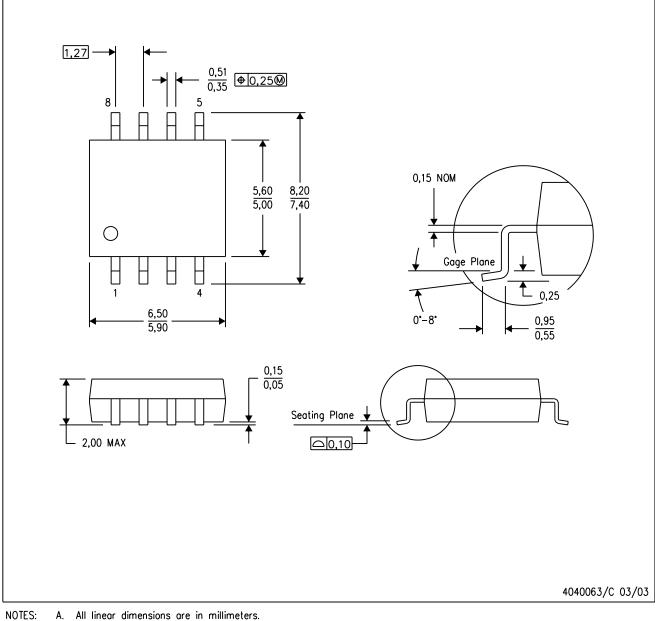
9. Board assembly site may have different recommendations for stencil design.



### **MECHANICAL DATA**

### PS (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE

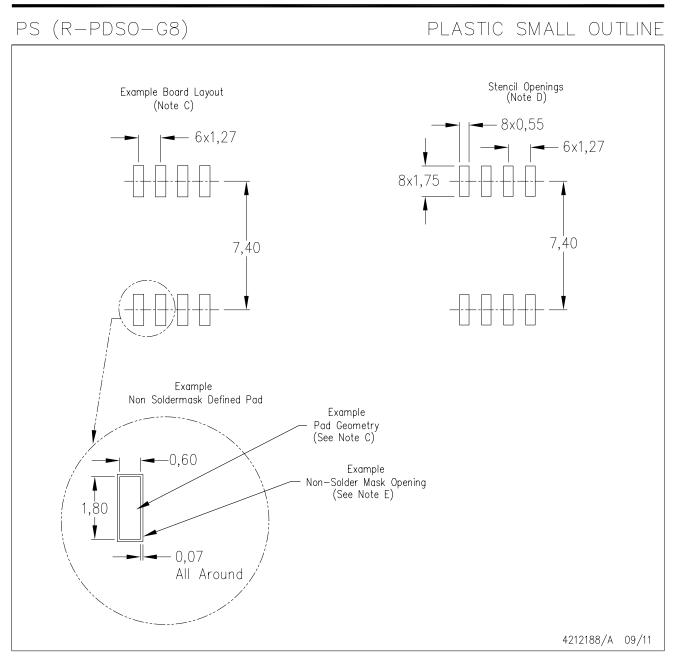


A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.





NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

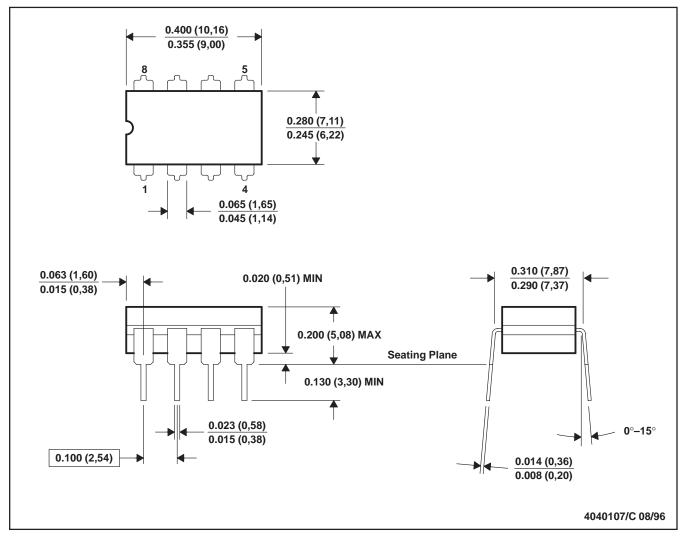


## **MECHANICAL DATA**

MCER001A - JANUARY 1995 - REVISED JANUARY 1997



#### **CERAMIC DUAL-IN-LINE**



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification.
- E. Falls within MIL STD 1835 GDIP1-T8



P(R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 variation BA.



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